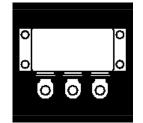
Preliminary Data Sheet

OM6056SB OM6058SB OM6060SB OM6057SB OM6059SB OM6061SB

POWER MOSFETS IN A HERMETIC ISOLATED POWER BLOCK PACKAGE



High Current, High Voltage 100V Thru 1000V, Up To 190 Amp N-Channel, Size 7 MOSFETs

FEATURES

- Size 7 Die, High Energy
- Rugged Package Design
- Solder Terminals
- Very Low R_{DS(on)}
- Fast Switching, Low Drive Current
- Available Screened To MIL-S-19500, TX, TXV And S Levels
- Ceramic Feedthroughs

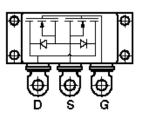
DESCRIPTION

This series of hermetically packaged products feature the latest advanced MOSFET technology combined with a package designed specifically for high efficiency, high current applications. They are ideally suited for Hi-Rel requirements where small size, high performance and high reliability are required, and in applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high energy pulse circuits. This series also features avalanche high energy capability at elevated temperatures.

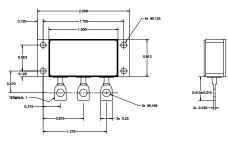
MAXIMUM RATINGS @ 25°C

PART NUMBER	V _{DS}	R _{DS(on)}	I _D (Continuous)
OM6056SB	100 V	.008 Ω	190 A
OM6057SB	200 V	.018 Ω	105 A
OM6058SB	500 V	.095 Ω	58 A
OM6059SB	600 V	.140 Ω	48 A
OM6060SB	800 V	.300 Ω	34 A
OM6061SB	1000 V	.500 Ω	18 A

PIN CONNECTION AND SCHEMATIC



MECHANICAL OUTLINE



3.1

3.1 - 107

OM6056SB - OM6061SB

3.1

ABSOLUTE MAXIMUM RATINGS (T_c = 25°C unless otherwise noted)

Parameter	Symbol	OM6056SB	OM6057SB	OM6058SB	OM6059SB	OM6060SB	OM6061SB	Unit
Drain Source Voltage	V _{DS}	100	200	500	600	800	1000	V
Drain Gate Voltage ($R_{GS} = 1.0 M\Omega$)	V_{DGR}	100	200	500	600	800	1000	V
Continuous Drain Current @ $T_c = 25^{\circ}C^2$	Ι _D	190	105	58	48	34	18	А
Continuous Drain Current @ TC = $100^{\circ}C^{2}$	Ι _D	82	44	25	19	15	7.5	А
Pulsed Drain Current ¹	I _{DM}	440	250	130	110	78	42	А
Max. Power Dissipation @ $T_c = 25^{\circ}C$	P _D	570					W	
Max. Power Dissipation @ T _c = 100°C	P _D	245					W	
Linear Derating Factor Junction-to-Case		4.35					W/°C	
Linear Derating Factor Junction-to-Ambient		.033					W/°C	
Operating and Storage Temp. Range	T _J , T _{stg}	-55 to +150					°C	
Lead Temperature (1/16" from case for 10 sec	5.)	230				°C		

Notes: 1. Pulse Test: Pulse Width \leq 300 μ sec, Duty Cycle \leq 2%. 2. Package Pin Limitation: 100 Amps @ 125°C.

THERMAL RESISTANCE (MAXIMUM) @ TAF 25

Junction-to-Ambient (Free Air Operation)	30	° C/W

PRELIMINARY ELECTRICAL CHARACTERISTICS (T_c = 25°C unless otherwise noted)

Characteristic	Test Condition		Symbol	Part No.	Min.	Max.	Units
Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu \text{A}$		V _{GS(th)}	All	2.0	4.0	V
Gate-Source Leakage Current	$V_{GS} = \pm 20 V_{DC}$		I _{GSS}	All		±100	nA
Off State Drain-Source Leakage	$V_{DS} = V_{DSS} \times 0.8$	T _c = 25°C	I _{DSS}	All		10	μA
	$V_{GS} = 0V$	T _c = 125°C	I _{DSS}	All		.10	mA
Drain-Source Breakdown Voltage V _G	V _{GS} = 0V, I _D = 250 μA			OM6056SB	100		- - - -
				OM6057SB	200		
			V _{DSS}	OM6058SB	500		
			V DSS	OM6059SB	600		
				OM6060SB	800		
				OM6061SB	1000		
Static Drain-Source On-Resistance V _{GS} = 10V,				OM6056SB		.008	
	V _{GS} = 10V, I _D = I _{D25} x 0.5		R _{DS(on)}	OM6057SB		.018	Ω
				OM6058SB		.095	
				OM6059SB		.140	
				OM6060SB		.300	
				OM6061SB		.500	

The above data is preliminary. Please contact factory for additional data and the dynamic and switching characteristics.

Committeel 🗱 205 Commond Street Lournington, MA 01153 USA (508) 531-5778 FAX (508) 537-5248